Product Data Sheet

Amphenol® HDB³ Series High Density Mother Board & Daughter Board Connectors

No. 201-3

Rectangular Interconnects with .070" X .060" Grid Spacing

This new connector series incorporates a higher density contact pattern and lower mated height than Amphenol's original Low Mating Force rectangular connectors while utilizing the same durable and reliable B³ contact.

The B³ brush (bristle brush bunch) contact is comprised of multiple strands of high tensile wire that intermesh to create an electrical connection.



- Redundant current paths: 14-70 gas tight points of contact per mated bunch
- · Very smooth low friction interface
- Low mating forces: 1.5 oz. typical per contact, 70-90% lower than conventional contacts
- Long contact life: 100,000 cycles of mating and unmating without performance degradation
- Documented intermittency free performance: No 10 nano-second discontinuities during 50,000,000 cycles of 0.010" displacement
- · Impervious to fretting
- Contact interface meets M55302/166 thru /171

HDB³ FEATURES

Polarization: "D" shaped design

Keying: Optional keys offer 36 unique

keying combinations

Guide Pins Optional guide pins provide

additional alignment

Radial Misalignment: Capable of correcting up to a

.020" initial radial misalign-

ment

Angular Misalignment: Capable of mating with up to a

2° initial angular misalignment



HDB³ CONNECTOR PERFORMANCE

Durability: 100,000 mating cycles

Insertion/Extraction Force: 1.5 ounce typical per contact

Operating Temperature: -65° to 150°C Current Rating: 2 amperes

HDB 3 Daughter Board

Connector

Hot swap 1 ampere maximum

(load dependent)

Insulation Resistance: 5 gigaohms minimum

Dielectric Withstanding

Voltage: 750 volts, 60 hertz, rms @ Sea

Level 250 volts, 60 hertz, rms @ 70,000 feet Elevation MIL-STD-202, Method 208

Solderability: MIL-STD-202, Method 208
Salt Fog: 48 Hours IAW MIL-STD-1344,

method 1001, test condition B

Humidity: IAW MIL-STD-1344, method

1002, type II

Vibration: 4 hours in each of 3 mutually

perpendicular axes IAW MIL-ST 1344, method 2005,

test condition V, letter H

Shock: 1 shock along each of three mutually perpendicular axes IAW

MIL-STD-1344, method 2004,

test condition G

Data Rate: Capable of 3.125 Gbps (consult

Amphenol for arrangement)

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HDB³ MATERIALS

Insulator: Liquid crystal polymer, 30% glass filled

Contact: Wire: Beryllium copper per ASTM B197; finish is gold per ASTM B488

over nickel per AMS-QQ-N-290.

Holder: Brass similar to UNS C33500; finish is gold per MIL-G-45204 or tin-lead per

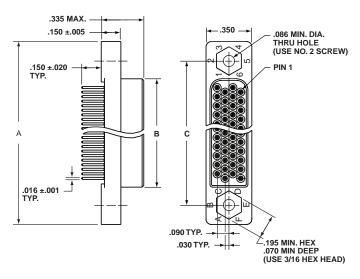
MIL-P-81728 or tin per MIL-T-10727 (RoHS Compliant).

Sleeve: Stainless Steel per AMS-5514, passivated IAW QQ-P-35

(Daughter Board connector only)

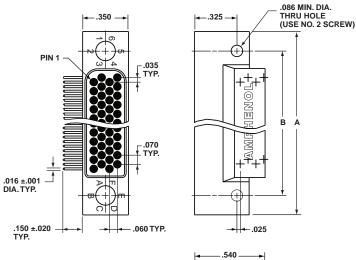
Keys/Guide Pins: Stainless Steel

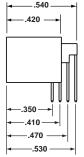
MOTHER BOARD



	Number of Contacts	Dimension A	Dimension B	Dimension C
040	40	1.375	0.800	1.075
080	80	2.075	1.500	1.775
120	120	1.775	2.200	2.475
160	160	3.475	2.900	3.175

DAUGHTER BOARD

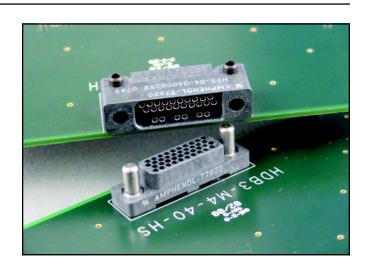




All dimensions for reference only.

CUSTOM CONFIGURATIONS

- Hybrid configurations are available with any combination of brush and power, coax, and/or fiber optic contacts
- Partially populated arrangements for high voltage or high speed data transfer up to 3.125 Gbps. (shown at right)
 Consult Amphenol Aerospace with your design requirements.



HDB3 MOTHER BOARD CONNECTOR HOW TO ORDER

Designates HDB3 Mother Board Connectors -

Example part number: **HDB-M4 - 040 M 20 2**

Hardware

i iai u	i iai uwai e			
	Туре	Stickout (Dim. K)		
Х	No Hardware	N/A		
G	Polarization Key Qty. 2	0.250		
Н	Polarization Key Qty. 2	0.500		
J	Polarization Key Qty. 2	0.750		
Т	Guide Pin Qty. 2	0.250		
U	Guide Pin Qty. 2	0.500		
٧	Guide Pin	0.750		

Number of Contacts -

HDB-M4

	Number of Contacts	Dimension A	Dimension B	Dimension C
040	40	1.375	0.800	1.075
080	80	2.075	1.500	1.775
120	120	1.775	2.200	2.475
160	160	3.475	2.900	3.175

Brush Wire Plating —

М	0.000050 Au Min. thick over Nickel
С	0.000020 Au Min. thick over Nickel

Termination -

20 PCB, Straight, .016 Dia. 0.060 21 PCB, Straight, .016 Dia 0.090 22 PCB, Straight, .016 Dia 0.120 23 PCB, Straight, .016 Dia 0.150	101111	illation	
20 PCB, Straight, .016 Dia. 0.060 21 PCB, Straight, .016 Dia 0.090 22 PCB, Straight, .016 Dia 0.120 23 PCB, Straight, .016 Dia 0.150		Type	Stickout
21 PCB, Straight, .016 Dia 0.090 22 PCB, Straight, .016 Dia 0.120 23 PCB, Straight, .016 Dia 0.150			(Dim. E)
22 PCB, Straight, .016 Dia 0.120 23 PCB, Straight, .016 Dia 0.150	20	PCB, Straight, .016 Dia.	0.060
23 PCB, Straight, .016 Dia 0.150	21	PCB, Straight, .016 Dia	0.090
	22	PCB, Straight, .016 Dia	0.120
24 PCB Straight 016 Dia 0 180	23	PCB, Straight, .016 Dia	0.150
27 1 0D, Ollaight, 1010 Dia 0.100	24	PCB, Straight, .016 Dia	0.180
25 PCB, Straight, .016 Dia 0.210	25	PCB, Straight, .016 Dia	0.210

	Туре	Stickout
		(Dim. E)
26	PCB, Straight, .016 Dia	0.240
27	PCB, Straight, .016 Dia	0.270
28	PCB, Straight, .016 Dia	0.300
29	PCB, Straight, .016 Dia	0.360
30	PCB, Straight, .016 Dia	0.420

Contact Terminition Finish

Gold plated in accordance with MIL-G-45204, Type II, .00030 Min. thick Gold over .000050 Min. thick Nickel

Qty. 2

- Tin plated in accordance with ASTM B545, .00010 Min. thick Matte Tin over .00010 Min. thick
- Tin-Lead plated in accordance with SAE-AMS-P-81728, .00010 Min. thick Tin-Lead over .00010 Min. thick Copper

HDB-M4-XXXXXXXX drawing is available on-line at www.amphenol-aerospace.com. Then go to board level, then go to HDB3.

HDB³ DAUGHTER BOARD CONNECTOR HOW TO ORDER

Example part number: **HDB-D4 - 040**

HDB-D4 Designates HDB³ Daughter Board Connectors —

Number of Contacts

	Number of	Dimension	Dimension	Dimension
	Contacts	Α	В	С
040	40	1.375	0.800	1.075
080	80	2.075	1.500	1.775
120	120	1.775	2.200	2.475
160	160	3.475	2.900	3.175

Brush Wire Plating _____

	,
M	0.000050 Au Min. thick over Nickel
С	0.000020 Au Min, thick over Nickel

Termination -

	Туре	Stickout
		(Dim. E)
00	PCB, Right Angle, .016 Dia.	0.060
01	PCB, Right Angle, .016 Dia.	0.090
02	PCB, Right Angle, .016 Dia.	0.120
03	PCB, Right Angle, .016 Dia.	0.150
04	PCB, Right Angle, .016 Dia.	0.180
05	PCB, Right Angle, .016 Dia.	0.210
06	PCB, Right Angle, .016 Dia.	0.300

Hardware

	Туре
Х	No Hardware
Р	Polarization Key Qty. 2
L	Polarization Key Qty. 2

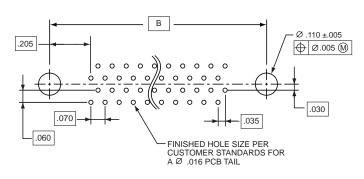
Contact Terminition Finish

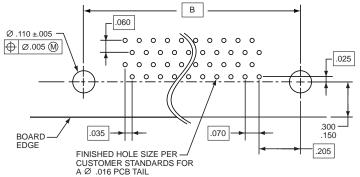
- Gold plated in accordance with MIL-G-45204, Type II, .00030 Min. thick Gold over .000050 Min. thick Nickel
- Tin plated in accordance with ASTM B545, .00010 Min. thick Matte Tin over .00010 Min. thick Nickel
- Tin-Lead plated in accordance with SAE-AMS-P-81728, .00010 Min. thick Tin-Lead over .00010 Min. thick Copper

HDB-D4-XXXXXXXX drawing is available on-line at www.amphenol-aerospace.com. Then go to board level, then go to HDB3.

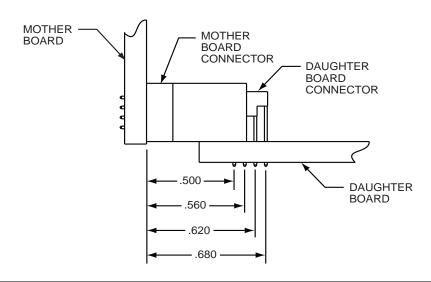
Recommended Mother Board Layout

Recommended Daughter Board Layout

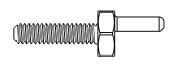




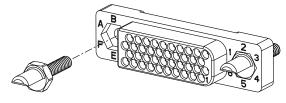
Dimensions		
No. of Contacts	В	
40	1.075	
80	1.775	
120	2.475	
160	3.175	



Mother Board Connector Keying (Optional)

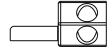


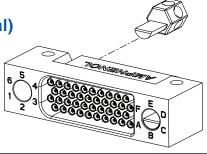




Daughter Board Connector Keying (Optional)







CONNECTOR COMPARISON

The Amphenol HDB³ Connector offers advantages over competitive connectors:

- · Higher density contact pattern
- · Uses less board space
- · Allows for shorter mated height
- · Provides the durability and performance of the Brush contact
- · Low cost

		Amphenol HDB ³	Hypertronics HPH	Airborn RM4
Contact System	Contact System		Hyperboloid	Pin & Socket
Durability, Mating Cycles	3	100,000	2,000	500
Contact Mating Forces, (Dunces	1.5	1.5	2.5
	Mother Board	.070 X .060	.075 X .075	.075 X .070
Contact Arrangement	Daughter Board	.070 X .060	.075 X .100	.075 X .100
Connector Width		.350	.443	.400
Mated Height, MB to 4th row of DB.		680	.986	.915
	Contacts			
	40	29		
	80	38		
Contacts per Linear	86			37
Inch (Contacts/	102		37	
Connector Length)	120	43		
	110			40
	160	46		
	164			40

For additional information on this product or other Amphenol products contact:

Amphenol Corporation Amphenol Aerospace 40-60 Delaware Avenue Sidney, New York 13838-1395

Phone: 800-678-0141 and ask for BLP (Board Level Product) Marketing

Email: blp-marketing @amphenol-aerospace.com

Web: www.amphenol-aerospace.com

See Amphenol Low Mating Force Rectangular Connectors Catalog, 12-035.

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